

DECLARATION FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name. I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled PRINTED CIRCUIT BOARD AND METHOD OF MANUFACTURING SAME, which is described and claimed in

- ☐ the attached specification.
☐ the specification in application _____, filed on _____
and amended on _____ (if applicable).
☒ international (PCT) application No. FCT/JP99/03664, filed on 07 / 07 / 1999
and as amended on 21 / 04 / 2000 (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is known to be material to the patentability of this application in accordance with Title 37, Code of Federal Regulations, §1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed.

Prior Foreign Application(s)

<u>Pat. Appln. No. 10-192992</u>	<u>Japan</u>	<u>08 / 07 / 1998</u>
(Number)	(Country)	(Day/Month/Year Filed)
_____	_____	_____
(Number)	(Country)	(Day/Month/Year Filed)
_____	_____	_____
(Number)	(Country)	(Day/Month/Year Filed)

Priority Claimed

☒ Yes ☐ No

☐ Yes ☐ No

☐ Yes ☐ No

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose information which is known to be material to the patentability of this application as defined in Title 37, Code of Federal Regulations, §1.56 which occurred between the filing date of the prior application and the national or PCT International filing date of this application.

_____	_____	_____
(Application Number)	(Filing Date)	(Status - Patented, Pending, Abandoned)
_____	_____	_____
(Application Number)	(Filing Date)	(Status - Patented, Pending, Abandoned)

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith: James F. Boyle, Reg. No. 33,653; Timothy E. Newholm, Reg. No. 34,400; Timothy J. Ziolkowski, Reg. No. 38,368; David D. Stein, Reg. No. 40,828; Michael J. Gratz, Reg. No. 39,693; Matthew M. Eslami, Reg. No. 45,488.

Address all telephone calls to James F. Boyle at telephone number (414) 225-9755, facsimile number (414) 225-9753.

Address all correspondence to: **James F. Boyle**
BOYLE FREDRICKSON ZIOLKOWSKI S.C.
250 Plaza, Suite 1030
250 East Wisconsin Avenue
Milwaukee, Wisconsin 53202

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or first inventor (given name, family name): Kiyotaka TSUKADA

Inventor's signature: Kiyotaka Tsukada Date: December 13, 2000

Residence: Ogaki-shi, Japan Citizenship: Japan

Post Office Address: c/o IBIDEN CO., LTD. 2-1, Kanda-cho, Ogaki-shi,
Gifu 503-0917 Japan

Title:

Inventor(s):

Full name of second joint inventor, if any (given name, family name): Masaru TAKADA

Inventor's signature: Masaru Takada Date: December 13, 2000
Residence: Ogaki-shi, Japan Citizenship: Japan
Post Office Address: c/o IBIDEN CO., LTD. 2-1, Kanda-cho, Ogaki-shi,
Gifu 503-0917 Japan

SEE ATTACHED SUPPLEMENTAL SHEET

